

STD28P3LLH6AG

Automotive-grade P-channel -30 V, 0.027 Ω typ., -12 A STripFET™ H6 Power MOSFET in a DPAK package

Datasheet - production data



Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ρτοτ
STD28P3LLH6AG	-30V	0.030Ω	-12A	33W

- Designed for automotive applications and AEC-Q101 qualified
- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss
- Logic level

Applications

Switching applications

Description

This device is a P-channel Power MOSFET developed using the STripFETTM H6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low $R_{DS(on)}$ in all packages.

Table 1: Device summary

Order code	Marking	Package	Packing
STD28P3LLH6AG	28P3LLH6	DPAK	Tape and reel

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	-30	V
V _{GS}	Gate-source voltage	±18	V
I _D ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	10	٨
ID. 7	Drain current (continuous) at T _{case} = 100 °C		A
I _{DM} ⁽²⁾	Drain current (pulsed)	-48	А
Ртот	Total dissipation at T _{case} = 25 °C	33	W
E _{AS} ⁽³⁾	Single pulse avalanche energy	210	mJ
T _{stg}	Storage temperature	-55 to 150	°C
Tj	Maximum operating junction temperature	150	°C

Notes:

⁽¹⁾Limited by wire bonding

⁽²⁾ Pulse width is limited by safe operating area.

 $^{(3)}$ starting T_j = 25 °C, I_{AS} =-6 A, V_DD = -25 V, V_{gs} = -10 V .

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	3.75	
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50	°C/W

Notes:

 $^{(1)}$ When mounted on a 1-inch² FR-4, 2 Oz copper board



2 Electrical characteristics

 $(T_{case} = 25 \text{ °C unless otherwise specified})$

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-30			V
		V_{GS} = 0 V, V_{DS} = -30 V			-1	
I _{DSS}	I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = -30 V,$ $T_{case} = 125 \text{ °C}$			-10	μA
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = \pm 18 V$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-1		-2.5	V
D	Static drain-source on- resistance	V_{GS} = -10 V, I_{D} = -6 A		0.027	0.03	Ω
R _{DS(on)}		V_{GS} = -4.5 V, I _D = -6 A		0.038	0.05	Ω

Table	5:	Dynamic

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
Ciss	Input capacitance		-	1480	I	
C _{oss}	Output capacitance	V _{DS} = -25 V, f = 1 MHz, V _{GS} = 0 V		170	-	pF
C _{rss}	Reverse transfer capacitance			125	-	
Qg	Total gate charge			29	-	
Q _{gs}	Gate-source charge	$V_{DD} = -15 \text{ V}, \text{ I}_D = -12 \text{ A}, \text{ V}_{GS} = -10 \text{ V}$ (see Figure 14: "Gate charge test circuit")	-	4.7	-	nC
Q_gd	Gate-drain charge	chourt y	-	5.6	-	

Table 6: Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	10	-	
tr	Rise time	$V_{DD} = -15 \text{ V}, \text{ I}_D = -6 \text{ A} \text{ R}_G = 4.7 \Omega,$	-	7.9	-	
t _{d(off)}	Turn-off delay time	V _{GS} = -10 V (see Figure 13: "Switching times test circuit for resistive load")	-	41.5	-	ns
t _f	Fall time		-	6.9	-	

Electrical characteristics

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	Table 7: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
I _{SD}	Source-drain current		-		-12	А		
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		-48	A		
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = -12 A$	-		-1.3	V		
t _{rr}	Reverse recovery time		-	17.8		ns		
Q _{rr}	Reverse recovery charge	I_{SD} = -12 A, di/dt = 100 A/µs, V _{DD} = -24 V (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	10.2		nC		
I _{RRM}	Reverse recovery current		-	-1.2		A		

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area.

 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.



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Electrical characteristics







For the P-channel Power MOSFET, current and voltage polarities are reversed.

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3 Test circuits







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 DPAK (TO-252) type A package information



Figure 16: DPAK (TO-252) type A package outline



Package information

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nformation			STD28P3LLH6AG
	Table 8: DPAK (TO-252	2) type A mechanical dat	ta
Dim.		mm	
2	Min.	Тур.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	4.60	4.70	4.80
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
(L1)	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°



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Package information





4.2 DPAK (TO-252) packing information





Figure 19: DPAK (TO-252) reel outline

Package information



Table 9: DPAK (TO-252) tape and reel mechanical data						
	Таре			Reel		
Dim	m	ım	Dim	mm		
Dim.	Min.	Max.	Dim.	Min.	Max.	
A0	6.8	7	А		330	
B0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
E	1.65	1.85	N	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1	Base	e qty.	2500	
P1	7.9	8.1	Bulk	qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

Table 9: DPAK (TO-252) tape and reel mechanical data



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
21-Sep-2015	1	First release.



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